Selection Guide

		7C261-20 7C263-20 7C264-20	7C261-25 7C263-25 7C264-25	7C261-35 7C263-35 7C264-35	7C261-45 7C263-45 7C264-45	7C261-55 7C263-55 7C264-55
Maximum Access Time (ns)		20	25	35	45	55
Maximum Operating Current (mA)	Commercial	120	120	100	100	100
	Military		140	120	120	120
Maximum Standby Current (mA) (7C261 only)	Commercial	40	40	30	30	30
	Military		40	30	30	30

Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperatures .....–65°C to+150°C

Ambient Temperature with Power Applied.....–55°C to+125°C

Supply Voltage to Ground Potential (Pin 24 to Pin 12) .....–0.5V to+7.0V

DC Voltage Applied to Outputs in High Z State .....–0.5V to+7.0V

DC Input Voltage..... –3.0V to + 7.0V

DC Program Voltage (Pin 19 DIP, Pin 23 LCC) 13.0V

Static Discharge Voltage.....>2001V (per MIL-STD-883, Method 3015)

Latch-Up Current..... >200 mA

UV Exposure ..... 7258 Wsec/cm^2

Operating Range

Range	Ambient Temperature	V_{CC}
Commercial	0°C to + 70°C	5V ± 10%
Industrial[1]	–40°C to + 85°C	5V ± 10%
Military[2]	–55°C to + 125°C	5V ± 10%

Notes:
1. See the Ordering Information section regarding industrial temperature range specification.
2. T_A is the “instant on” case temperature.

Electrical Characteristics Over the Operating Range[3,4]

Parameter	Description	Test Conditions		7C261-20, 25 7C263-20, 25 7C264-20, 25		7C261-35, 45, 55 7C263-35, 45, 55 7C264-35, 45, 55		Unit
				Min.	Max.	Min.	Max.	
V_{OH}	Output HIGH Voltage	V_{CC} = Min., I_{OH} = –2.0 mA		2.4				V
V_{OH}	Output HIGH Voltage	V_{CC} = Min., I_{OH} = –4.0 mA				2.4		V
V_{OL}	Output LOW Voltage	V_{CC} = Min., I_{OL} = 8 mA (6 mA Mil)			0.4			V
V_{OL}	Output LOW Voltage	V_{CC} = Min., I_{OL} = 16 mA					0.4	V
V_{IH}	Input HIGH Level			2.0		2.0		V
V_{IL}	Input LOW Level				0.8		0.8	V
I_{IX}	Input Current	GND ≤ V_{IN} ≤ V_{CC}		–10	+10	–10	+10	µA
V_{CD}	Input Diode Clamp Voltage			Note 4		Note 4		
I_{OZ}	Output Leakage Current	GND ≤ V_{OUT} ≤ V_{CC} Output Disabled	Com'l	–10	+10	–10	+10	µA
			Mil	–40	+40	–40	+40	µA
I_{OS}	Output Short Circuit Current[5]	V_{CC} = Max., V_{OUT} = GND		–20	–90	–20	–90	mA
I_{CC}	Power Supply Current	V_{CC} = Max., f = Max. I_{OUT} = 0 mA	Com'l		120		100	mA
			Mil		140		120	
I_{SB}	Standby Supply Current (7C261)	V_{CC} = Max., $\overline{CS}$ ≥ V_{IH}	Com'l		40		30	mA
			Mil		40		30	
V_{PP}	Programming Supply Voltage			12	13	12	13	V
I_{PP}	Programming Supply Current				50		50	mA
V_{IHP}	Input HIGH Programming Voltage			4.75		4.75		V
V_{ILP}	Input LOW Programming Voltage				0.4		0.4	V

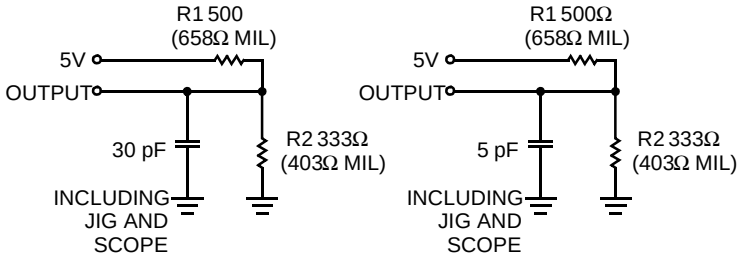
Notes:
3. See the last page of this specification for Group A subgroup testing information.
4. See the "Introduction to CMOS PROMs" section of the Cypress Data Book for general information on testing.
5. For test purposes, not more than one output at a time should be shorted. Short circuit test duration should not exceed 30 seconds.]

Capacitance[4]

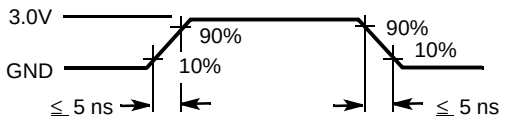
Parameter	Description	Test Conditions	Max.	Unit
C_{IN}	Input Capacitance	T_A = 25°C, f = 1 MHz, V_{CC} = 5.0V	10	pF
C_{OUT}	Output Capacitance		10	pF

AC Test Loads and Waveforms[4]

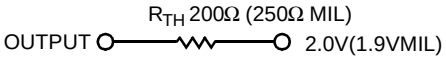
Test Load for -20 through -30 speeds



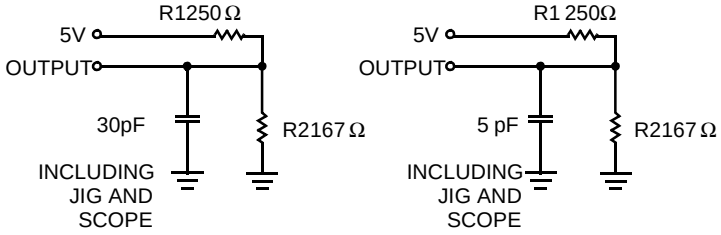
(a) Normal Load **(b) High Z Load**



Equivalent to: THÉVENIN EQUIVALENT



Test Load for -35 through -55 speeds



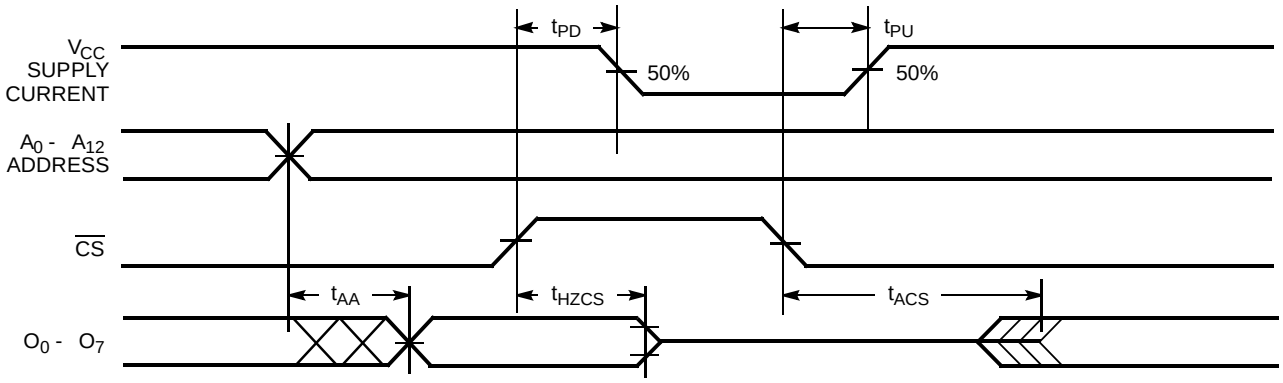
(c) Normal Load **(d) High Z Load**

Equivalent to: THÉVENIN EQUIVALENT

Switching Characteristics Over the Operating Range [2,3,4]

Parameter	Description	7C261-20 7C263-20 7C264-20		7C261-25 7C263-25 7C264-25		7C261-35 7C263-35 7C264-35		7C261-45 7C263-45 7C264-45		7C261-55 7C263-55 7C264-55		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t_{AA}	Address to Output Valid		20		25		35		45		55	ns
t_{HZCS1}	Chip Select Inactive to High Z (7C263 and 7C264)		12		12		20		30		35	ns
t_{HZCS2}	Chip Select Inactive to High Z (7C261)		20		25		35		45		55	ns
t_{ACS1}	Chip Select Active to Output Valid (7C263 and 7C264)		12		12		20		30		35	ns
t_{ACS2}	Chip Select Active to Output Valid (7C261)		20		25		35		45		55	ns
t_{PU}	Chip Select Active to Power-Up (7C261)	0		0		0		0		0		ns
t_{PD}	Chip Select Inactive to Power-Down (7C261)		20		25		35		45		55	ns

Switching Waveforms[4]



Erasure Characteristics

Wavelengths of light less than 4000 angstroms begin to erase the devices in the windowed package. For this reason, an opaque label should be placed over the window if the PROM is exposed to sunlight or fluorescent lighting for extended periods of time.

The recommended dose of ultraviolet light for erasure is a wavelength of 2537 angstroms for a minimum dose (UV intensity multiplied by exposure time) of 25 Wsec/cm^2. For an ultraviolet lamp with a 12 mW/cm^2 power rating, the exposure time would be approximately 35 minutes. The 7C261 or 7C263 needs to be within 1 inch of the lamp during erasure. Permanent damage may result if the PROM is exposed to high-intensity UV light for an extended period of time. 7258 Wsec/cm^2 is the recommended maximum dosage.

Operating Modes

Read

Read is the normal operating mode for programmed device. In this mode, all signals are normal TTL levels. The PROM is addressed with a 13-bit field, a chip select, (active LOW), is applied to the $\overline{CS}$ pin, and the contents of the addressed location appear on the data out pins.

Program, Program Inhibit, Program Verify

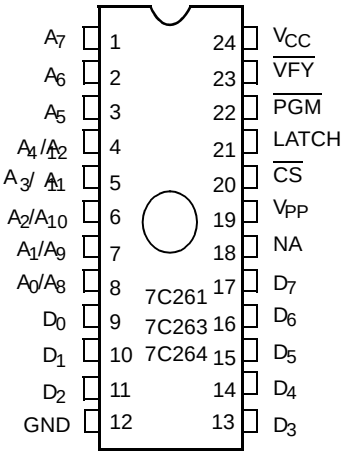
These modes are entered by placing a high voltage V_{PP} on pin 19, with pins 18 and 20 set to V_{ILP}. In this state, pin 21 becomes a latch signal, allowing the upper 5 address bits to be latched into an onboard register, pin 22 becomes an active LOW program ($\overline{PGM}$) signal and pin 23 becomes an active LOW verify ($\overline{VFY}$) signal. Pins 22 and 23 should never be active LOW at the same time. The PROGRAM mode exists when $\overline{PGM}$ is LOW, and $\overline{VFY}$ is HIGH. The verify mode exists when the reverse is true, $\overline{PGM}$ HIGH and $\overline{VFY}$ LOW and the program inhibit mode is entered with both $\overline{PGM}$ and $\overline{VFY}$ HIGH. Program inhibit is specifically provided to allow data to be placed on and removed from the data pins without conflict

Table 1. Mode Selection

Mode		Pin Function[6, 7]						
	Read or Output Disable	A_{12}	A_{11}	A_{10}	A_9	A_8	$\overline{CS}$	O_7–O_0
	Program	NA	V_{PP}	LATCH	$\overline{PGM}$	$\overline{VFY}$	$\overline{CS}$	D_7–D_0
Read		A_{12}	A_{11}	A_{10}	A_9	A_8	V_{IL}	O_7–O_0
Output Disable		A_{12}	A_{11}	A_{10}	A_9	A_8	V_{IH}	High Z
Program		V_{ILP}	V_{PP}	V_{ILP}	V_{ILP}	V_{IHP}	V_{ILP}	D_7–D_0
Program Inhibit		V_{ILP}	V_{PP}	V_{ILP}	V_{IHP}	V_{IHP}	V_{ILP}	High Z
Program Verify		V_{ILP}	V_{PP}	V_{ILP}	V_{IHP}	V_{ILP}	V_{ILP}	O_7–O_0
Blank Check		V_{ILP}	V_{PP}	V_{ILP}	V_{IHP}	V_{ILP}	V_{ILP}	O_7–O_0

Notes:
6. X = "don't care" but not to exceed V_{CC} ±5%.
7. Addresses A_8-A_{12} must be latched through lines A_0-A_4 in programming modes.

DIP/Flatpack
Top View



LCC/PLCC (Opaque only)
Top View

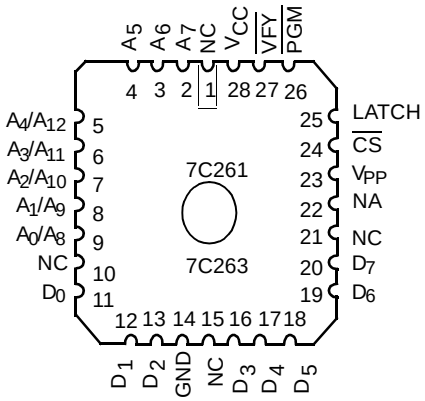


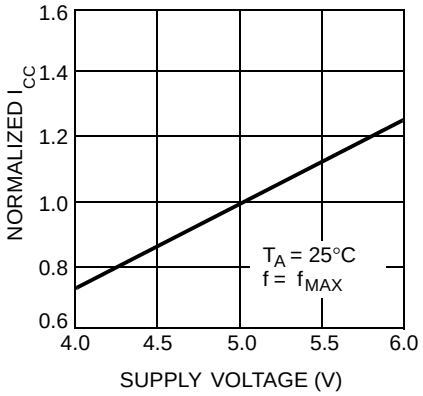
Figure 1. Programming Pinouts

Programming Information

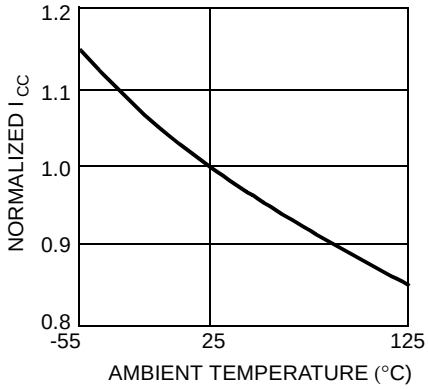
Programming support is available from Cypress as well as from a number of third-party software vendors. For detailed programming information, including a listing of software packages, please see the PROM Programming Information located at the end of this section. Programming algorithms can be obtained from any Cypress representative.

Typical DC and AC Characteristics

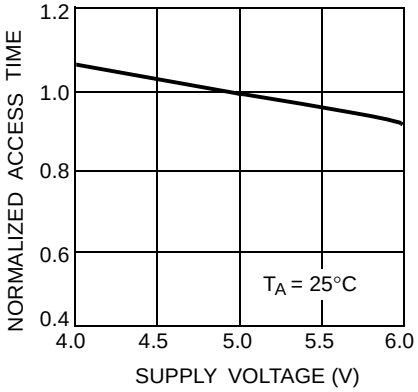
NORMALIZED SUPPLY CURRENT vs. SUPPLY VOLTAGE



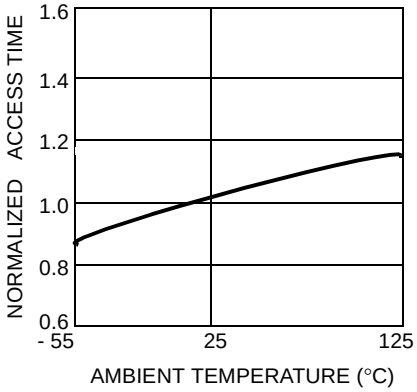
NORMALIZED SUPPLY CURRENT vs. AMBIENT TEMPERATURE



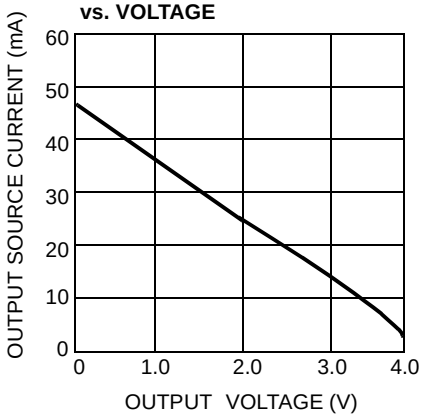
NORMALIZED ACCESS TIME vs. SUPPLY VOLTAGE



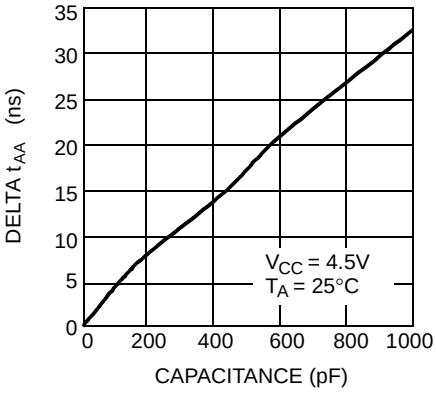
NORMALIZED ACCESS TIME vs. TEMPERATURE



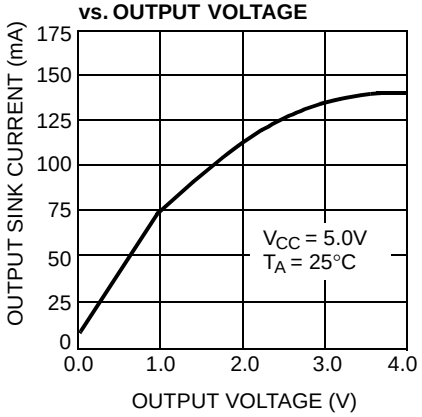
OUTPUT SOURCE CURRENT vs. VOLTAGE



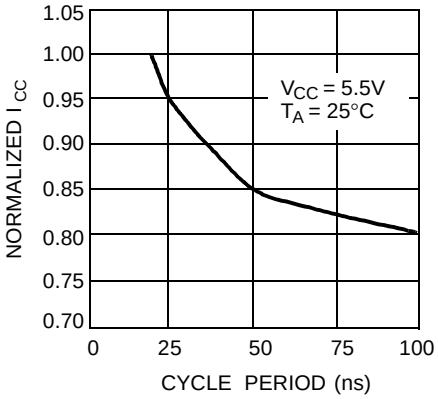
TYPICAL ACCESS TIME CHANGE vs. OUTPUT LOADING



OUTPUT SINK CURRENT vs. OUTPUT VOLTAGE



NORMALIZED SUPPLY CURRENT vs. CYCLE PERIOD



Ordering Information[8]

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
20	CY7C261-20JC	J64	28-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C261-20PC	P13	24-Lead (300-Mil) Molded DIP	
	CY7C261-20WC	W14	24-Lead (300-Mil) Windowed CerDIP	
25	CY7C261-25JC	J64	28-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C261-25PC	P13	24-Lead (300-Mil) Molded DIP	
	CY7C261-25WC	W14	24-Lead (300-Mil) Windowed CerDIP	
	CY7C261-25DMB	D14	24-Lead (300-Mil) CerDIP	Military
	CY7C261-25LMB	L64	28-Square Leadless Chip Carrier	
	CY7C261-25QMB	Q64	28-Pin Windowed Leadless Chip Carrier	
	CY7C261-25TMB	T73	24-Lead Windowed Cerpack	
	CY7C261-25WMB	W14	24-Lead (300-Mil) Windowed CerDIP	
35	CY7C261-35JC	J64	28-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C261-35PC	P13	24-Lead (300-Mil) Molded DIP	
	CY7C261-35WC	W14	24-Lead (300-Mil) Windowed CerDIP	
	CY7C261-35DMB	D14	24-Lead (300-Mil) CerDIP	Military
	CY7C261-35LMB	L64	28-Square Leadless Chip Carrier	
	CY7C261-35QMB	Q64	28-Pin Windowed Leadless Chip Carrier	
	CY7C261-35TMB	T73	24-Lead Windowed Cerpack	
	CY7C261-35WMB	W14	24-Lead (300-Mil) Windowed CerDIP	
45	CY7C261-45JC	J64	28-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C261-45PC	P13	24-Lead (300-Mil) Molded DIP	
	CY7C261-45WC	W14	24-Lead (300-Mil) Windowed CerDIP	
	CY7C261-45DMB	D14	24-Lead (300-Mil) CerDIP	Military
	CY7C261-45LMB	L64	28-Square Leadless Chip Carrier	
	CY7C261-45QMB	Q64	28-Pin Windowed Leadless Chip Carrier	
	CY7C261-45TMB	T73	24-Lead Windowed Cerpack	
	CY7C261-45WMB	W14	24-Lead (300-Mil) Windowed CerDIP	
55	CY7C261-55JC	J64	28-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C261-55PC	P13	24-Lead (300-Mil) Molded DIP	
	CY7C261-55WC	W14	24-Lead (300-Mil) Windowed CerDIP	
	CY7C261-55DMB	D14	24-Lead (300-Mil) CerDIP	Military
	CY7C261-55LMB	L64	28-Square Leadless Chip Carrier	
	CY7C261-55QMB	Q64	28-Pin Windowed Leadless Chip Carrier	
	CY7C261-55TMB	T73	24-Lead Windowed Cerpack	
	CY7C261-55WMB	W14	24-Lead (300-Mil) Windowed CerDIP	

Note:
8. Most of these products are available in industrial temperature range. Contact a Cypress representative for specifications and product availability.

Ordering Information[8] (continued)

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
20	CY7C263-20JC	J64	28-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C263-20PC	P13	24-Lead (300-Mil) Molded DIP	
	CY7C263-20WC	W14	24-Lead (300-Mil) Windowed CerDIP	
25	CY7C263-25JC	J64	28-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C263-25PC	P13	24-Lead (300-Mil) Molded DIP	
	CY7C263-25WC	W14	24-Lead (300-Mil) Windowed CerDIP	
	CY7C263-25DMB	D14	24-Lead (300-Mil) CerDIP	Military
	CY7C263-25LMB	L64	28-Square Leadless Chip Carrier	
	CY7C263-25QMB	Q64	28-Pin Windowed Leadless Chip Carrier	
	CY7C263-25TMB	T73	24-Lead Windowed Cerpack	
	CY7C263-25WMB	W14	24-Lead (300-Mil) Windowed CerDIP	
35	CY7C263-35JC	J64	28-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C263-35PC	P13	24-Lead (300-Mil) Molded DIP	
	CY7C263-35WC	W14	24-Lead (300-Mil) Windowed CerDIP	
	CY7C263-35DMB	D14	24-Lead (300-Mil) CerDIP	Military
	CY7C263-35LMB	L64	28-Square Leadless Chip Carrier	
	CY7C263-35QMB	Q64	28-Pin Windowed Leadless Chip Carrier	
	CY7C263-35TMB	T73	24-Lead Windowed Cerpack	
	CY7C263-35WMB	W14	24-Lead (300-Mil) Windowed CerDIP	
45	CY7C263-45JC	J64	28-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C263-45PC	P13	24-Lead (300-Mil) Molded DIP	
	CY7C263-45WC	W14	24-Lead (300-Mil) Windowed CerDIP	
	CY7C263-45DMB	D14	24-Lead (300-Mil) CerDIP	Military
	CY7C263-45LMB	L64	28-Square Leadless Chip Carrier	
	CY7C263-45QMB	Q64	28-Pin Windowed Leadless Chip Carrier	
	CY7C263-45TMB	T73	24-Lead Windowed Cerpack	
	CY7C263-45WMB	W14	24-Lead (300-Mil) Windowed CerDIP	
55	CY7C263-55JC	J64	28-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C263-55PC	P13	24-Lead (300-Mil) Molded DIP	
	CY7C263-55WC	W14	24-Lead (300-Mil) Windowed CerDIP	
	CY7C263-55DMB	D14	24-Lead (300-Mil) CerDIP	Military
	CY7C263-55LMB	L64	28-Square Leadless Chip Carrier	
	CY7C263-55QMB	Q64	28-Pin Windowed Leadless Chip Carrier	
	CY7C263-55TMB	T73	24-Lead Windowed Cerpack	
	CY7C263-55WMB	W14	24-Lead (300-Mil) Windowed CerDIP	

Ordering Information[8] (continued)

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
20	CY7C264-20DC	D12	24-Lead (600-Mil) CerDIP	Commercial
	CY7C264-20PC	P11	24-Lead (600-Mil) Molded DIP	
	CY7C264-20WC	W12	24-Lead (600-Mil) Windowed CerDIP	
25	CY7C264-25DC	D12	24-Lead (600-Mil) CerDIP	Commercial
	CY7C264-25PC	P11	24-Lead (600-Mil) Molded DIP	
	CY7C264-25WC	W12	24-Lead (600-Mil) Windowed CerDIP	
	CY7C264-25DMB	D12	24-Lead (600-Mil) CerDIP	Military
	CY7C264-25WMB	W12	24-Lead (600-Mil) Windowed CerDIP	
35	CY7C264-35DC	D12	24-Lead (600-Mil) CerDIP	Commercial
	CY7C264-35PC	P11	24-Lead (600-Mil) Molded DIP	
	CY7C264-35WC	W12	24-Lead (600-Mil) Windowed CerDIP	
	CY7C264-35DMB	D12	24-Lead (600-Mil) CerDIP	Military
	CY7C264-35WMB	W12	24-Lead (600-Mil) Windowed CerDIP	
45	CY7C264-45DC	D12	24-Lead (600-Mil) CerDIP	Commercial
	CY7C264-45PC	P11	24-Lead (600-Mil) Molded DIP	
	CY7C264-45WC	W12	24-Lead (600-Mil) Windowed CerDIP	
	CY7C264-45DMB	D12	24-Lead (600-Mil) CerDIP	Military
	CY7C264-45WMB	W12	24-Lead (600-Mil) Windowed CerDIP	
55	CY7C264-55DC	D12	24-Lead (600-Mil) CerDIP	Commercial
	CY7C264-55PC	P11	24-Lead (600-Mil) Molded DIP	
	CY7C264-55WC	W12	24-Lead (600-Mil) Windowed CerDIP	
	CY7C264-55DMB	D12	24-Lead (600-Mil) CerDIP	Military
	CY7C264-55WMB	W12	24-Lead (600-Mil) Windowed CerDIP	

MILITARY SPECIFICATION

Group A Subgroup Testing

DC Characteristics

Parameter	Subgroups
V_{OH}	1, 2, 3
V_{OL}	1, 2, 3
V_{IH}	1, 2, 3
V_{IL}	1, 2, 3
I_{IX}	1, 2, 3
I_{OZ}	1, 2, 3
I_{CC}	1, 2, 3
I_{SB}[9]	1, 2, 3

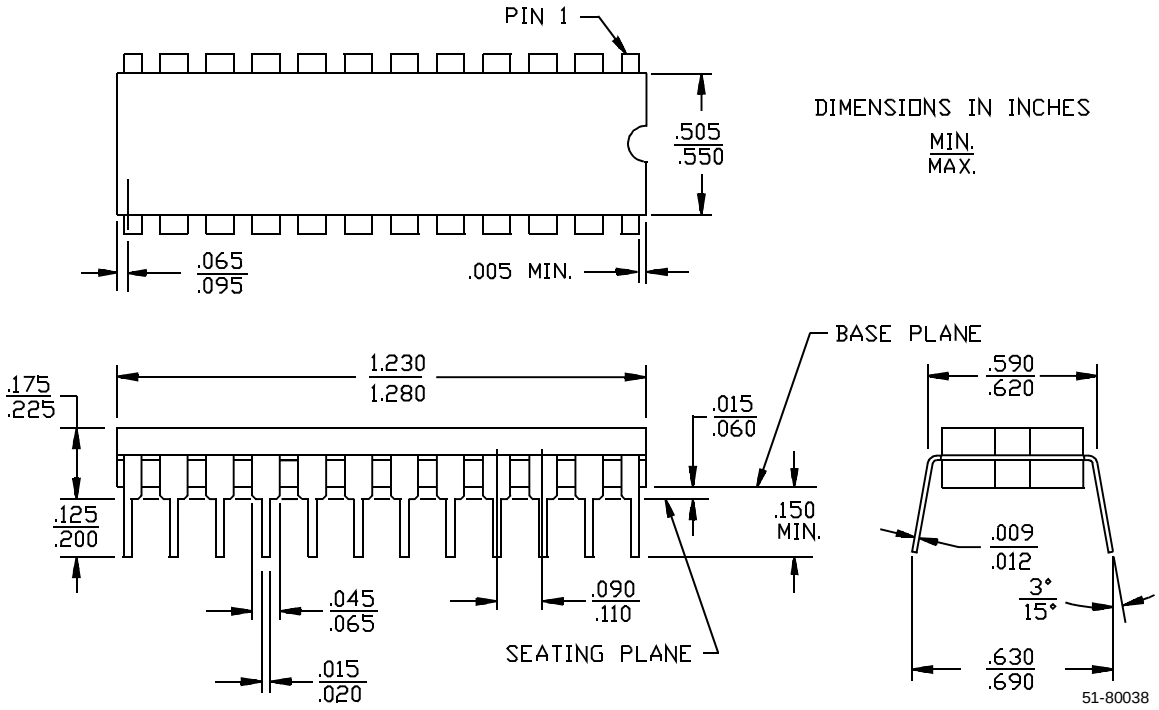
Switching Characteristics

Parameter	Subgroups
t_{AA}	7, 8, 9, 10, 11
t_{ACS1}[10]	7, 8, 9, 10, 11
t_{ACS2}[9]	7, 8, 9, 10, 11

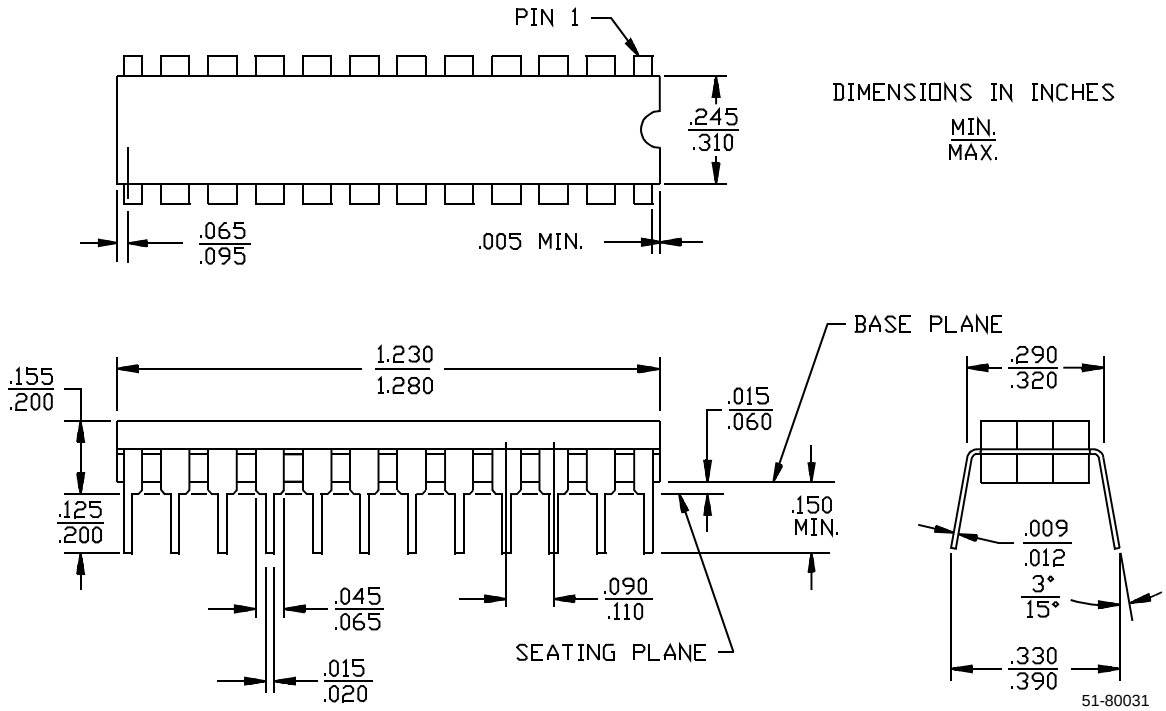
Notes:
9. 7C261 only.
10. 7C263 and 7C264 only.

Package Diagrams

24-Lead (600-Mil) CerDIP D12
MIL-STD-1835 D-3 Config. A

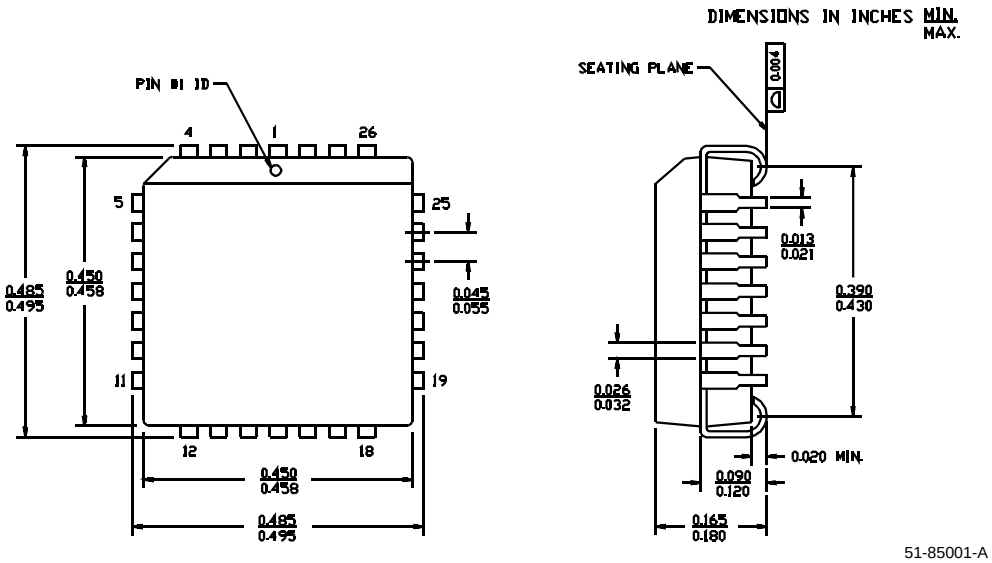


24-Lead (300-Mil) CerDIP D14
MIL-STD-1835 D-9 Config.A



Package Diagrams (continued)

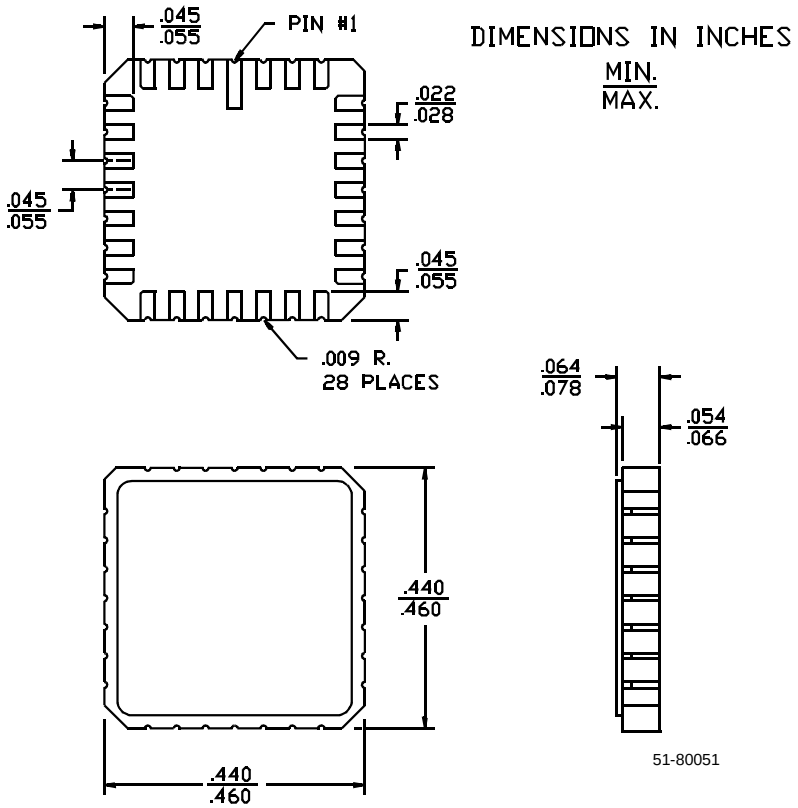
28-Lead Plastic Leaded Chip Carrier J64



51-85001-A

28-Square Leadless Chip Carrier L64

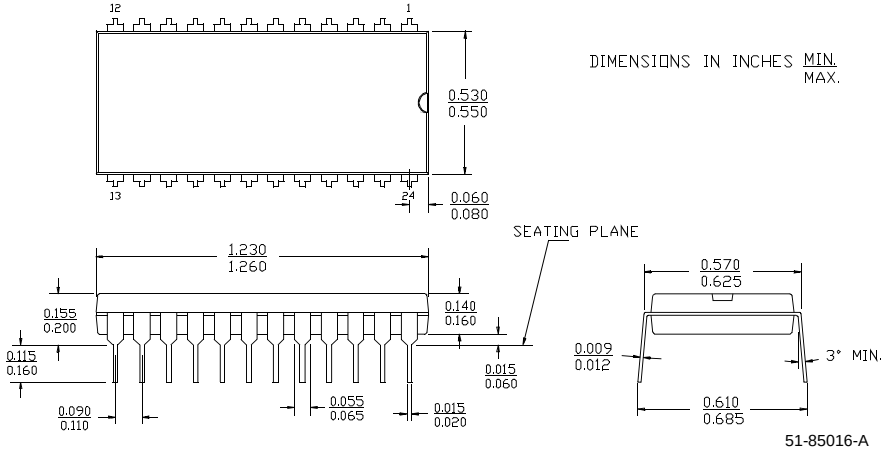
MIL-STD-1835 C-4



51-80051

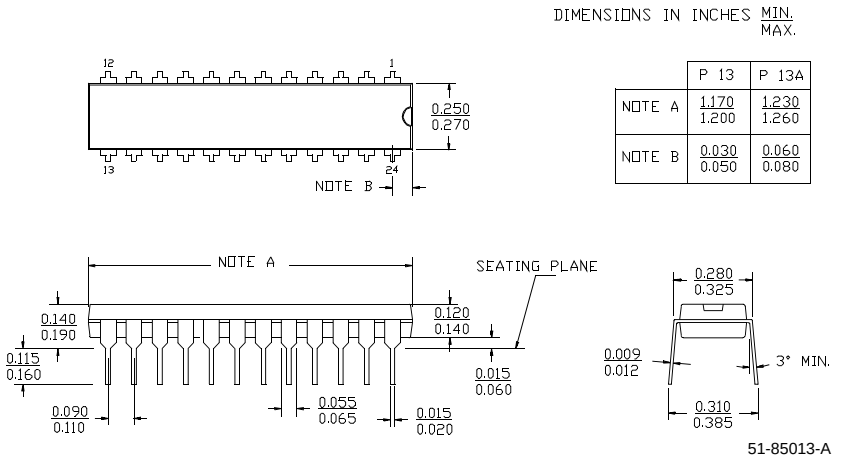
Package Diagrams (continued)

24-Lead (600-Mil) Molded DIP P11



51-85016-A

24-Lead (300-Mil) Molded DIP P13/P13A



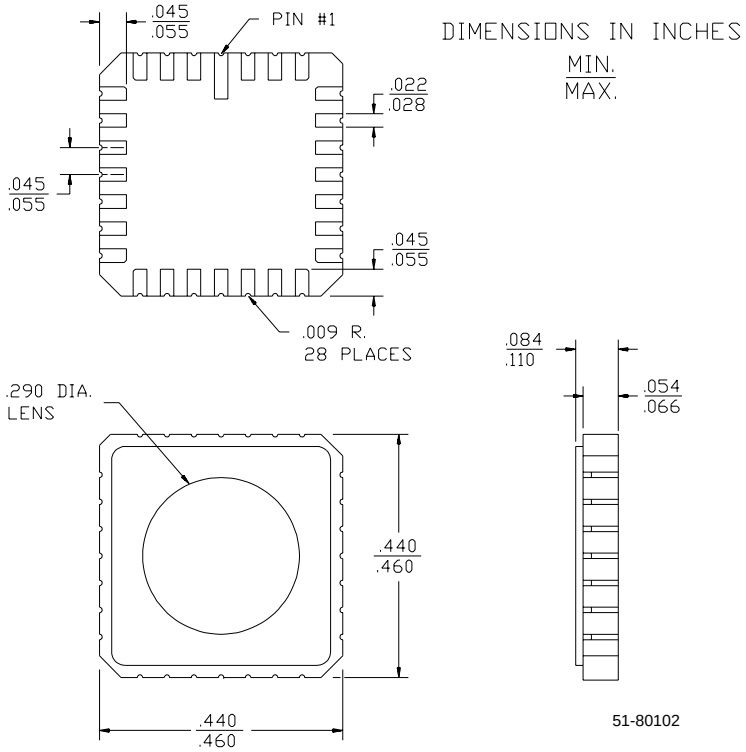
	P 13	P 13A
NOTE A	1.170 1.200	1.230 1.260
NOTE B	0.030 0.050	0.060 0.080

51-85013-A

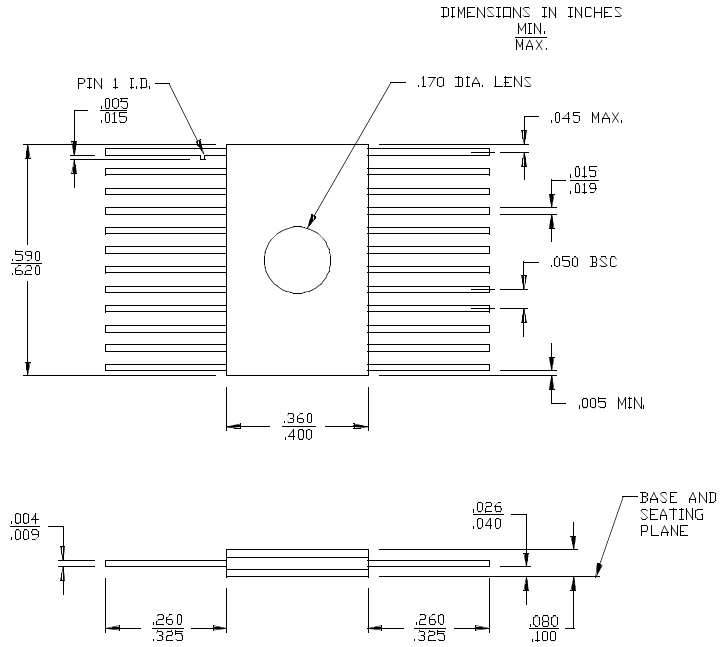
Package Diagrams (continued)

28-Pin Windowed Leadless Chip Carrier Q64

MIL–STD–1835 C–4

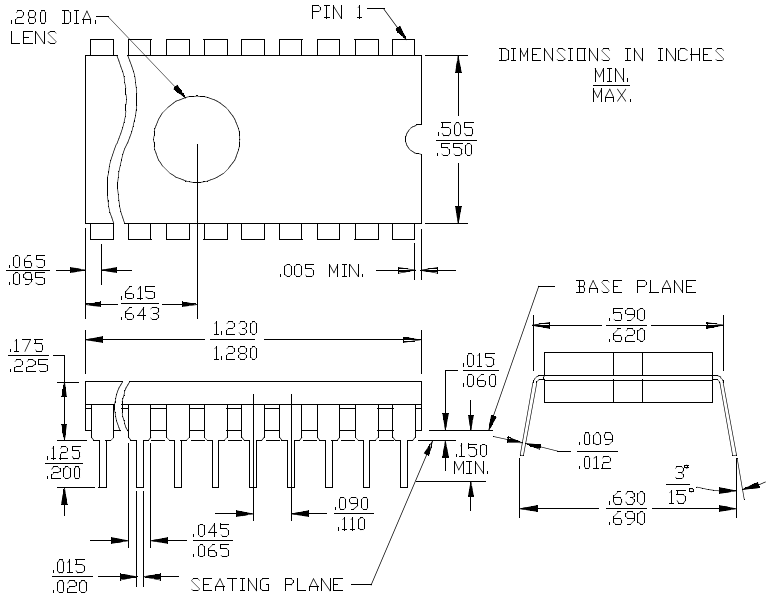


24-Lead Windowed Cerpack T73

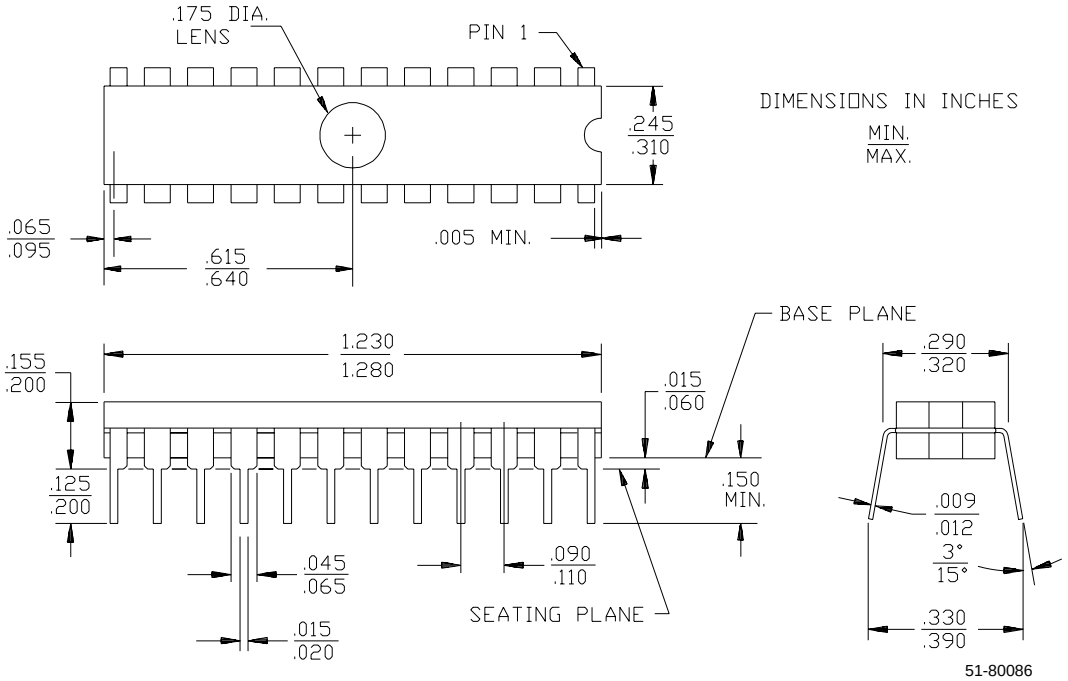


Package Diagrams (continued)

24-Lead (600-Mil) Windowed CerDIP W12
MIL-STD-1835 D-3 Config. A



24-Lead (300-Mil) Windowed CerDIP W14
MIL-STD-1835 D-9 Config. A



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**	113866	3/6/02	DSG	Change from Spec number: 38-00005 to 38-04010